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on Semiconductor® FQA9N90C-F109

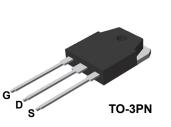
N-Channel QFET[®] MOSFET 900 V, 9 A, 1.4 Ω

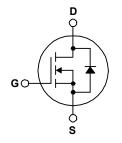
Features

- + 9 A, 900 V, R_{\rm DS(on)} = 1.4 Ω (Max.) @ V_{\rm GS} = 10 V, I_D = 4.5 A
- Low Gate Charge (Typ. 45 nC)
- Low Crss . 14 pF)
- 100% Avalanche Tested
- · RoHS compliant

Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQA9N90C-F109	Unit	
V _{DSS}	Drain-Source Voltage		900	V	
I _D	Drain Current - Continuous (T _C = 25°C)		9.0	А	
	- Continuous (T _C = 100°C)	5.7	А		
I _{DM}	Drain Current - Pulsed	(Note 1)	36	А	
V _{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	900	mJ	
I _{AR}	Avalanche Current	(Note 1)	9.0	А	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	28	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.0	V/ns	
P _D	Power Dissipation ($T_C = 25^{\circ}C$)		280	W	
	- Derate above 25°C		2.22	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
Τ _L	Maximum lead temperature for soldering purposes 1/8" from case for 5 seconds	з,	300	°C	

Thermal Characteristics

Symbol	Parameter	FQA9N90C_F109	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.45	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.24	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQA9N90C-F109	FQA9N90C	TO-3PN	Tube	N/A	N/A	30 units

Electrical Characteristics T_c = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics	1		I	1	
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I _D = 250 μ A	900			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		0.99		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\rm DS}$ = 900 V, $V_{\rm GS}$ = 0 V			10	μA
		V _{DS} = 720 V, T _C = 125°C			100	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = 30 V, V_{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0 V			-100	nA
On Charact	teristics			I		
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 4.5 A		1.12	1.4	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 4.5 A		9.2		S
Dynamic Ch	haracteristics					
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V,		2100	2730	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		175	230	pF
C _{rss}	Reverse Transfer Capacitance			14	18	pF
Switching C	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 450 V, I _D = 11.0A,		50	110	ns
t _r	Turn-On Rise Time	R _G = 25 Ω		120	250	ns
t _{d(off)}	Turn-Off Delay Time	=		100	210	ns
t _f	Turn-Off Fall Time	– (Note 4)		75	160	ns
Qg	Total Gate Charge	V _{DS} = 720 V, I _D = 11.0A, V _{GS} = 10 V		45	58	nC
Q _{gs}	Gate-Source Charge			13		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		18		nC
Drain-Sourc	ce Diode Characteristics and Maximum Ratings	5				
I _S	Maximum Continuous Drain-Source Diode Forward Current				9.0	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				36	А
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S =9.0 A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 9.0 A,		550		ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs		6.5		μC

Notes:

1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. L = 21 mH, I_{AS} = 9 A, V_{DD} = 50 V, R_G = 25 $\Omega,$ starting T_J = 25°C.

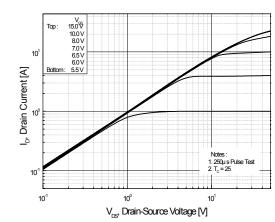
 $3.I_{SD} \leq 9$ A, di/dt ≤ 200 A/µs, $V_{DD} \leq BV_{DSS}$, starting T_J = 25°C.

4. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics



Figure 2. Transfer Characteristics





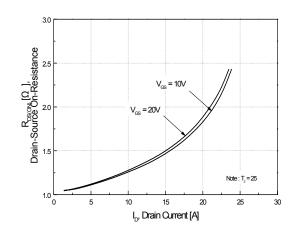
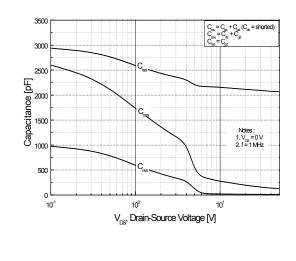
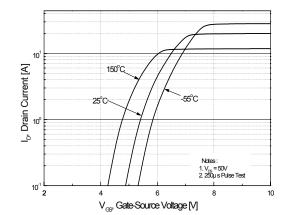


Figure 5. Capacitance Characteristics







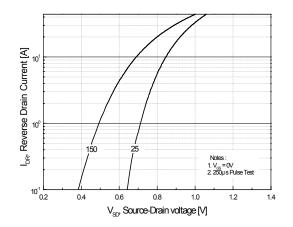
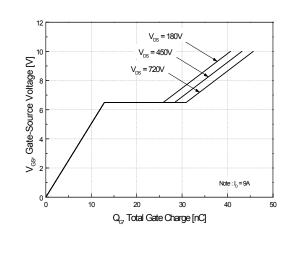
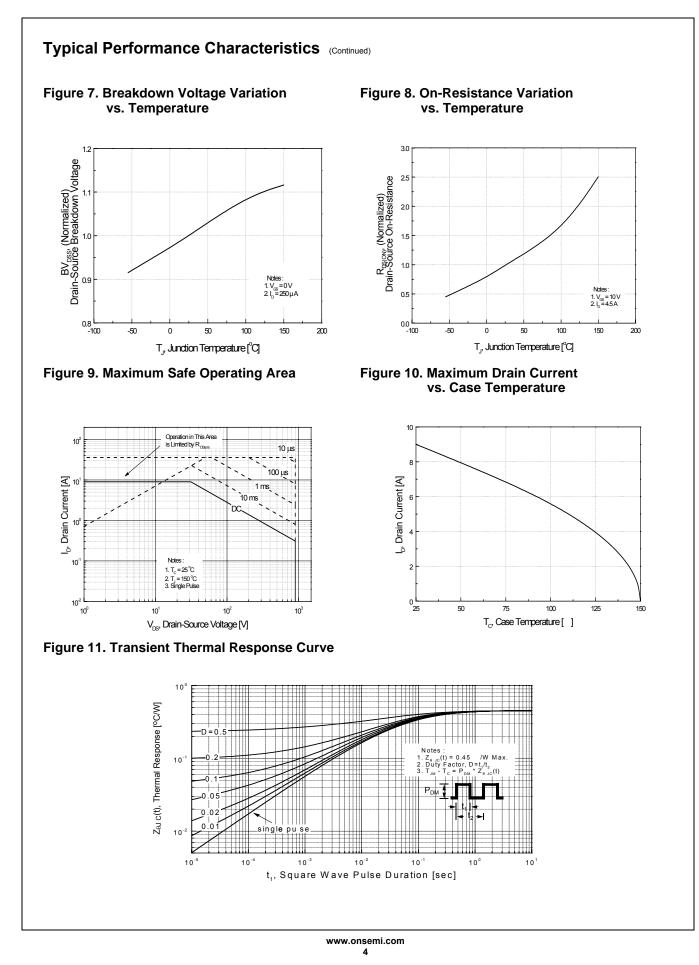
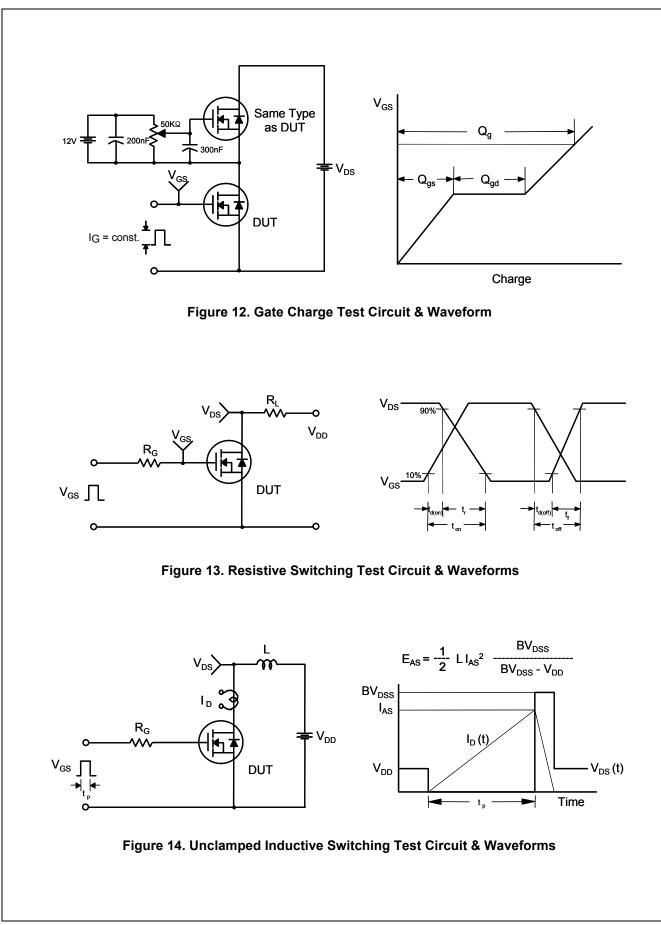


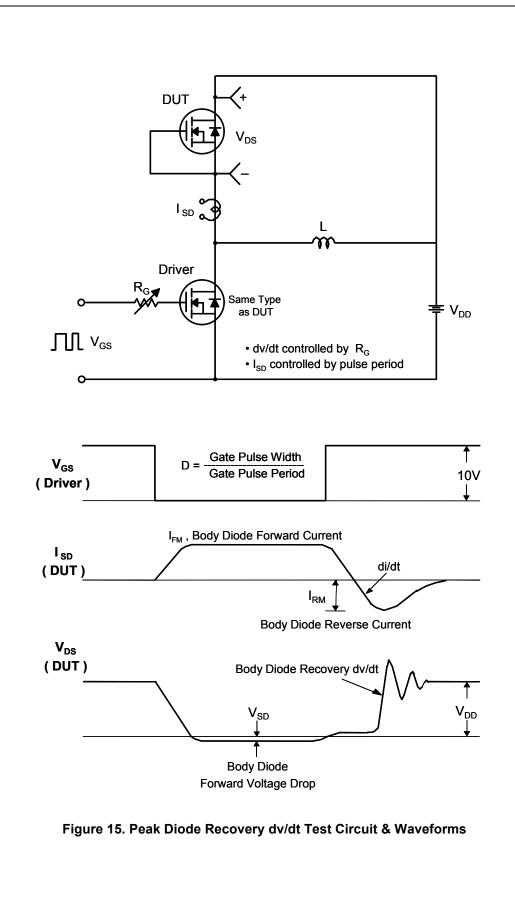
Figure 6. Gate Charge Characteristics

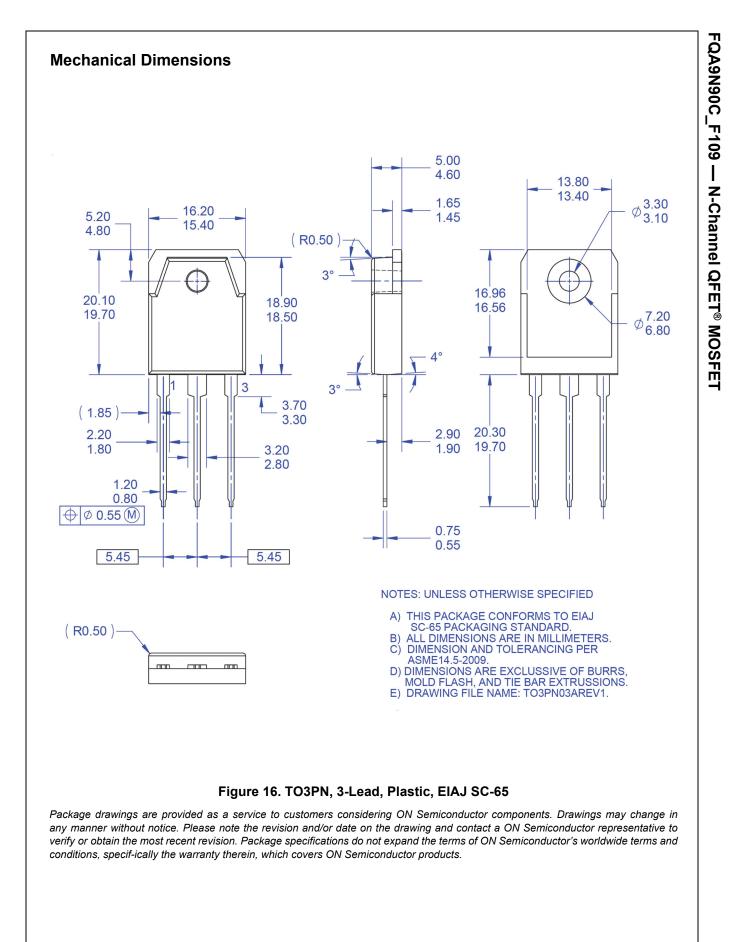




FQA9N90C_F109 — N-Channel QFET[®] MOSFET







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